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**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Appl. No.: 09/975,444 Confirmation No. 9172  
 Applicant: Ching-Te Lin et al. Filed: 10/11/2001  
 T/C/A.U.: 2814 Examiner: Long Pham  
 Docket No.: T1-31518 Customer No.: 23494

Title: **ELIMINATION OF OVERHANG IN LINER/BARRIER/SEED LAYERS USING POST-DEPOSITION SPUTTER ETCH**

**CERTIFICATION OF FACSIMILE TRANSMISSION**

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NAME OF INVENTOR(S):	
Lin et al	
TITLE OF INVENTION:	
Elimination of Overhang in Liner . . .	
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